P-TYPE SILICON PIN QUADRANT PHOTODIODE QDY7P



Quadrant PIN photodiode QDY7P is optimized for detection of radiation at 1060nm. A photodiode illuminated by visible and near infrared light behaves as a current source with photocurrent proportional to the power of detected radiation. Reverse bias increases parallel internal resistance and decreases capacity of diode. Decrease of capacity and of load resistance R_L decreases response time. Low capacity with relatively low bias is achieved by using extremely pure, high resistance silicon for the base Fregion of the diode (> 10 k Ω cm). Background radiation flux increases noise current, thus filters or darkening are recommanded to decrease this radiation. Influences of transition area width and cross-talk influence are minimized.

FEATURES

- High responsivity at 1060 nm
- Guard ring construction
- Fast response time
- Low capacity
- Low noise
- Low dark current
- Wide spectral range
- Linearity over wide dynamic range
- High reliability
- Selection upon request
- Fast delivery

APPLICATIONS

- Nd YAG laser pulse detection
- Navigation
- · Tracking and aligning

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TEHNICAL CHARACTERISTICS

- At 25°C, DC reverse operating voltage 200 V.
 Values are given per quadrant.

Parameter	typical	min	max	Request	Operating condition
Breakdown voltage (V)	450	250		>500	1 μΑ
Dark current (nA)	1.4		50	<1.2	
Responsivity at 900 nm (A/W)	0.6	0.5		0.65	
Responsivity at 1060 nm (A/W)	0.45	0.40			
NEP at 900nm (x10 ⁻¹¹ W/Hz ^{1/2})	<1.5		7	<1	
NEP at 1060nm (x10 ⁻¹¹ W/Hz ^{1/2})	<2.5		12	<1.5	
Capacitance (pF)	1.2		1.4	1.0	1 MHz
Response time (ns)	11			10	1060 nm, R=50Ω, 10%-90%
Approx. full angle for totally illuminated active area (°)	40				The values are dependent on dimensional tolerances of the package
Approx. full angle for partially illuminated active area(⁰)	91				The values are dependent on dimensional tolerances of the package
Active area (mm ²)	7				Total for all quadrants
Uniformity (%)	1		2		
Crosstalk (%)			4.0		

